



**产品规格手册**  
PRODUCT SPECIFICATION MANUAL

An abstract background graphic featuring a complex network of interconnected nodes. The nodes are represented by small circles in various colors (blue, purple, pink, yellow). The connections between them form a dense web of lines, suggesting a digital or technological theme.

## SI2302

N-Channel Advanced Power MOSFET  
SOT23/20V/3.6A



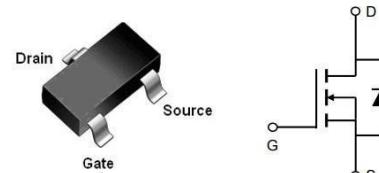
**Features**

- Low  $R_{DS(on)}$  @  $V_{GS}=4.5V$
- 3.3V Logic Level Control
- N Channel SOT23 Package
- Pb-Free, RoHS Compliant

$V_{(BR)DSS}$	$R_{DS(ON)}\text{ Typ}$	$I_D \text{ Max}$
20V	28mΩ @ 4.5V	3.6A
	32mΩ @ 3.3V	

**Applications**

- Load Switch
- DC/DC Converter
- Switching Circuits
- LED Driver

**SOT23****Order Information**

Product	Package	Marking	Packing	Min Unit Quantity
SI2302	SOT23	A2SHB	3000PCS/Reel	3000PCS

**Absolute Maximum Ratings**

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Symbol	Parameter	Rating	Unit
<b>Common Ratings (TA=25°C Unless Otherwise Noted)</b>			
$V_{GS}$	Gate-Source Voltage	$\pm 10$	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	20	V
$T_J$	Maximum Junction Temperature	150	°C
$T_{STG}$	Storage Temperature Range	-50 to 150	°C

## Mounted on Large Heat Sink

$I_{DM}$	Pulse Drain Current Tested①	$T_A = 25^\circ C$	18	A
$I_D$	Continuous Drain Current( $V_{GS}=4.5V$ )	$T_A = 25^\circ C$	3.6	A
		$T_A = 70^\circ C$	3.0	
$P_D$	Maximum Power Dissipation	$T_A = 25^\circ C$	1.2	W
		$T_A = 70^\circ C$	0.9	
$R_{θJA}$	Thermal Resistance Junction-Ambient		100	°C/W

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Electrical Characteristics @ <math>T_J = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	20	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current( $T_A=25^\circ\text{C}$ )	$V_{\text{DS}}=20\text{V}$ , $V_{\text{GS}}=0\text{V}$	--	--	1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_A=125^\circ\text{C}$ )	$V_{\text{DS}}=16\text{V}$ , $V_{\text{GS}}=0\text{V}$	--	--	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 10\text{V}$ , $V_{\text{DS}}=0\text{V}$	--	--	$\pm 100$	nA
$V_{\text{GS(TH)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=250\mu\text{A}$	0.4	0.6	1.0	V
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance <sup>②</sup>	$V_{\text{GS}}=4.5\text{V}$ , $I_D=4\text{A}$	--	28	35	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance <sup>②</sup>	$V_{\text{GS}}=3.3\text{V}$ , $I_D=2\text{A}$	--	32	40	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance <sup>②</sup>	$V_{\text{GS}}=2.5\text{V}$ , $I_D=1\text{A}$	--	36	45	$\text{m}\Omega$
<b>Dynamic Electrical Characteristics @ <math>T_J = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=10\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	--	280	--	pF
$C_{\text{oss}}$	Output Capacitance		--	46	--	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	42	--	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}=10\text{V}$ , $I_D=3\text{A}$ , $V_{\text{GS}}=5\text{V}$	--	4.7	--	nC
$Q_{\text{gs}}$	Gate Source Charge		--	0.6	--	nC
$Q_{\text{gd}}$	Gate Drain Charge		--	1.7	--	nC
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn on Delay Time	$V_{\text{DD}}=10\text{V}$ , $I_D=4\text{A}$ , $R_G=3.3\Omega$ , $V_{\text{GS}}=4.5\text{V}$	--	11	--	ns
$t_r$	Turn on Rise Time		--	35	--	ns
$t_{\text{d(off)}}$	Turn Off Delay Time		-	25	--	ns
$t_f$	Turn Off Fall Time		--	32	--	ns
<b>Source Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source drain current(Body Diode)	$T_A=25^\circ\text{C}$	--	--	1.8	A
$V_{\text{SD}}$	Forward on voltage <sup>②</sup>	$T_J=25^\circ\text{C}$ , $I_{\text{SD}}=2\text{A}$ , $V_{\text{GS}}=0\text{V}$	--	0.74	1.2	V

Notes:

① Pulse width limited by maximum allowable junction temperature

② Pulse test ; Pulse width 300μs, duty cycle 2%.

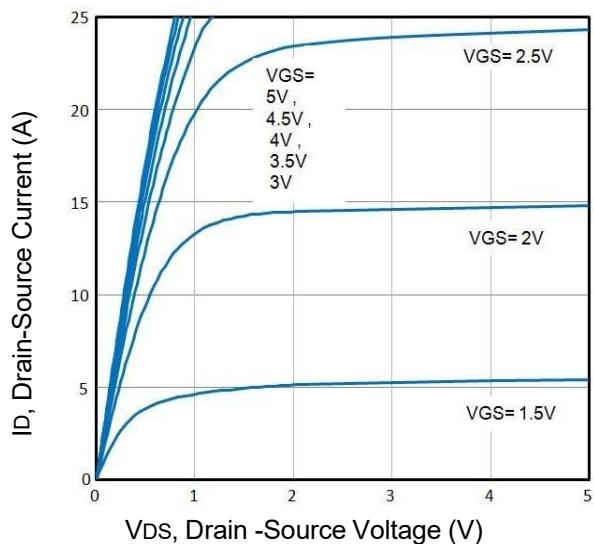


Fig1. Typical Output Characteristics

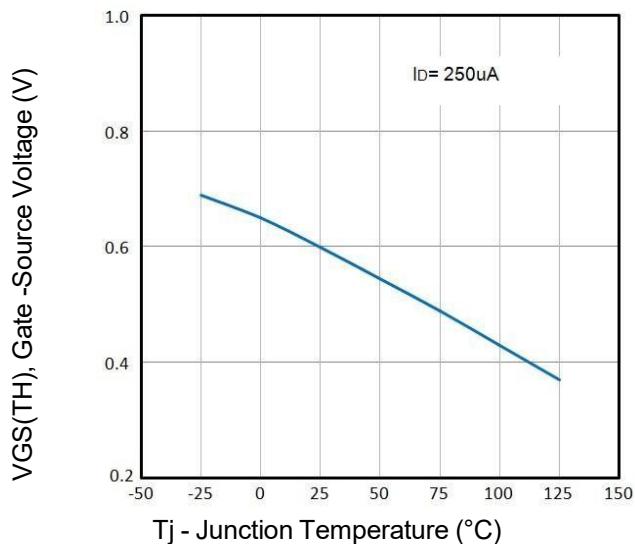


Fig2. Normalized Threshold Voltage Vs. Temperature

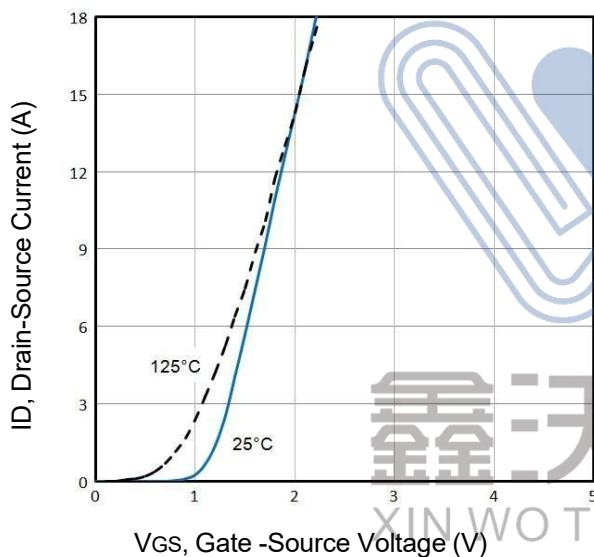


Fig3. Typical Transfer Characteristics

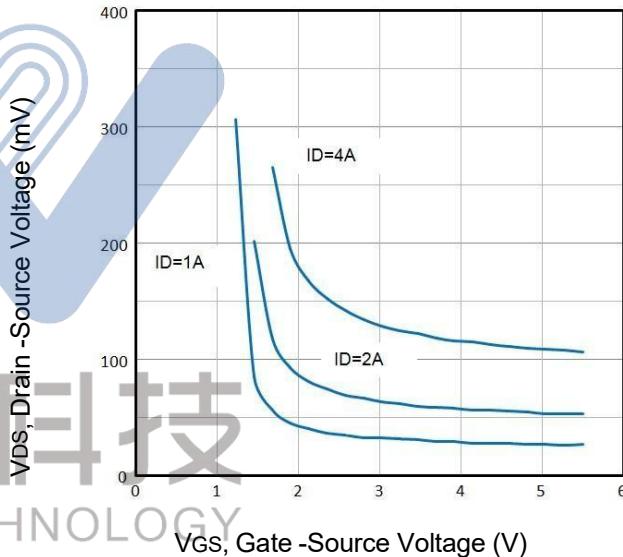


Fig4. Drain -Source Voltage vs Gate -Source Voltage

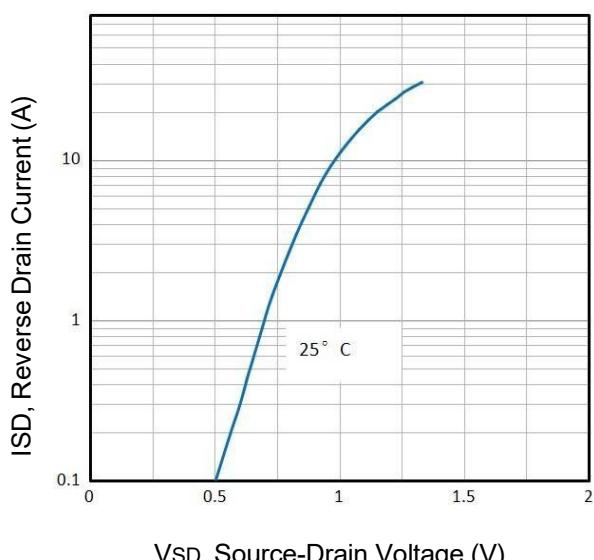


Fig5. Typical Source-Drain Diode Forward Voltage

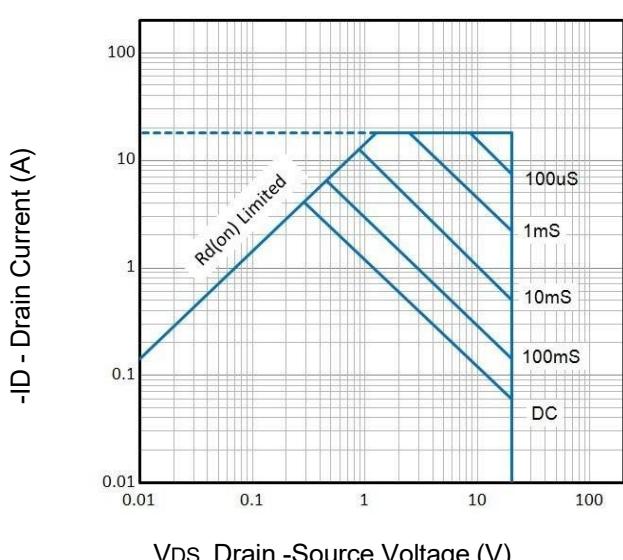


Fig6. Maximum Safe Operating Area

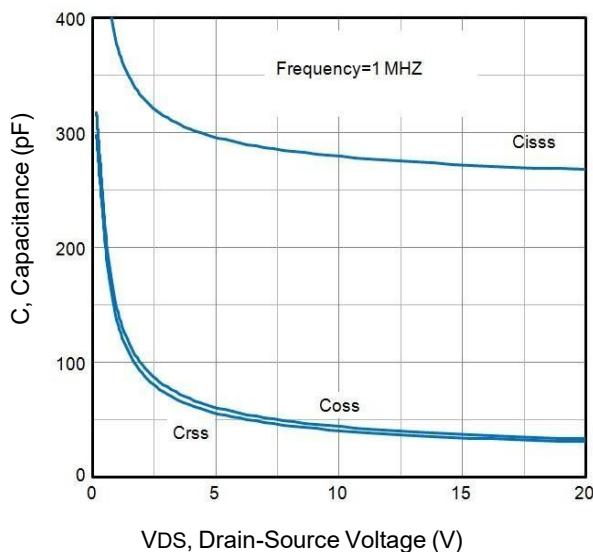


Fig7. Typical Capacitance Vs. Drain-Source Voltage

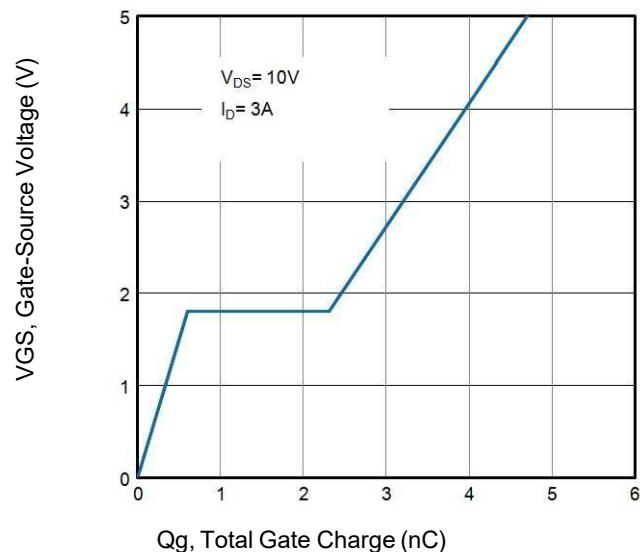


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

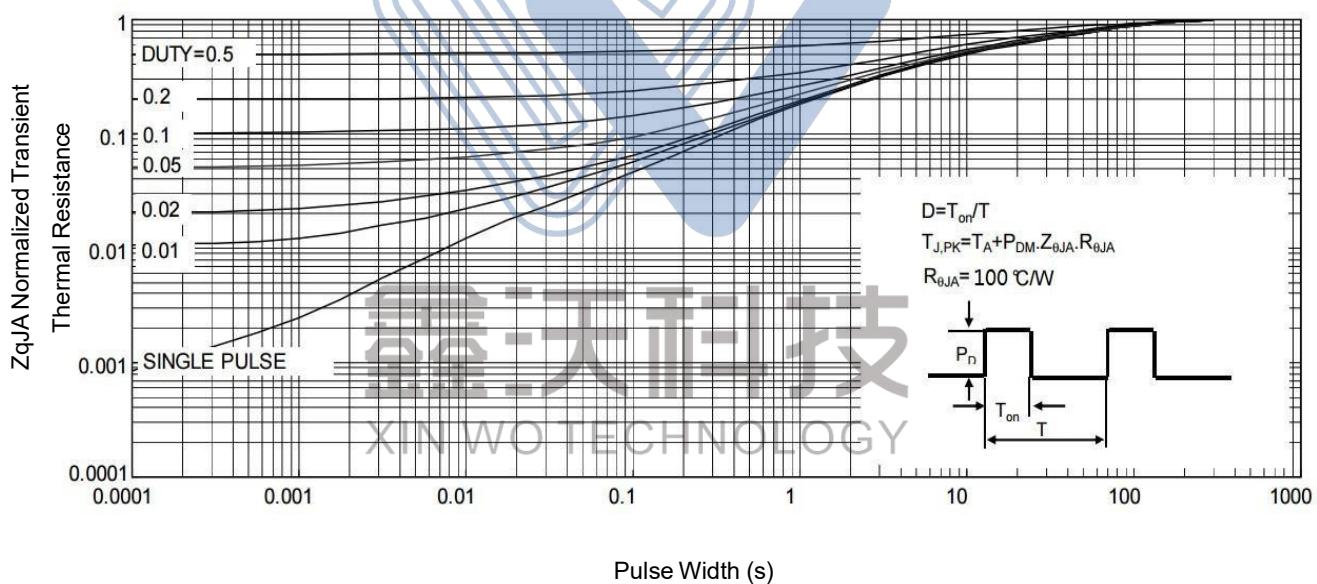


Fig9. Normalized Maximum Transient Thermal Impedance

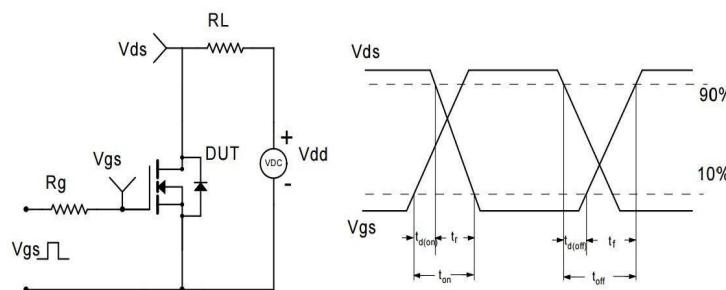
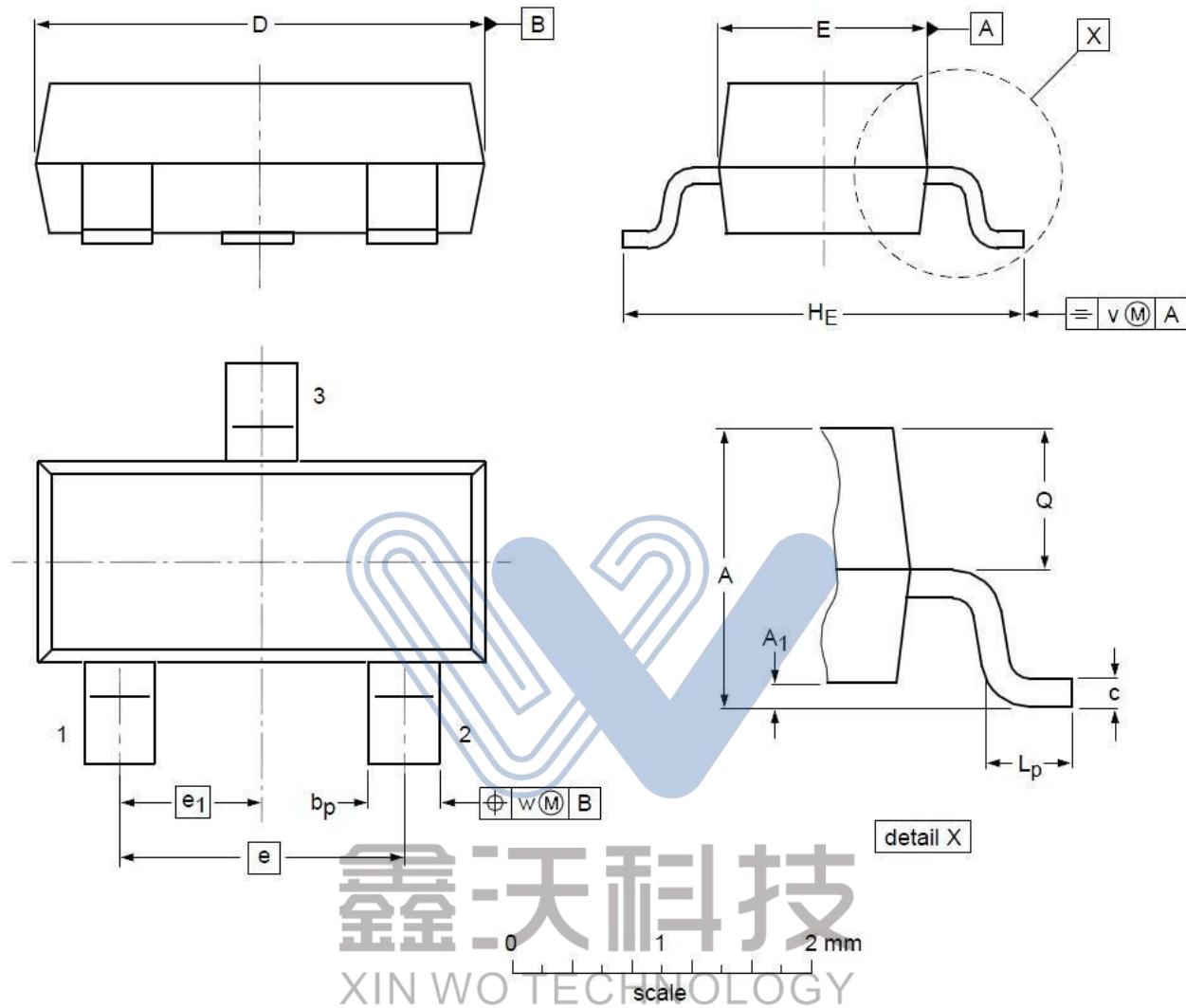


Fig10. Switching Time Test Circuit and waveforms

## SOT23 Mechanical Data



DIMENSIONS ( unit : mm )

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
<b>A</b>	0.90	1.01	1.15	<b>A<sub>1</sub></b>	0.01	0.05	0.10
<b>b<sub>p</sub></b>	0.30	0.42	0.50	<b>c</b>	0.08	0.13	0.15
<b>D</b>	2.80	2.92	3.00	<b>E</b>	1.20	1.33	1.40
<b>e</b>	--	1.90	--	<b>e<sub>1</sub></b>	--	0.95	--
<b>H<sub>E</sub></b>	2.25	2.40	2.55	<b>L<sub>p</sub></b>	0.30	0.42	0.50
<b>Q</b>	0.45	0.49	0.55	<b>v</b>	--	0.20	--
<b>w</b>	--	0.10	--				